





#### **Features**

- RoHS compliant
- Compatible with 155 Mbps ATM and SONET OC-3 SDH STM-1
- Industry standard 1×9 footprint
- SC Connector
- Single power supply 3.3 V
- Differential PECL inputs and outputs
- Compatible with solder and aqueous wash processes
- Class 1 laser product complies with EN 60825-1

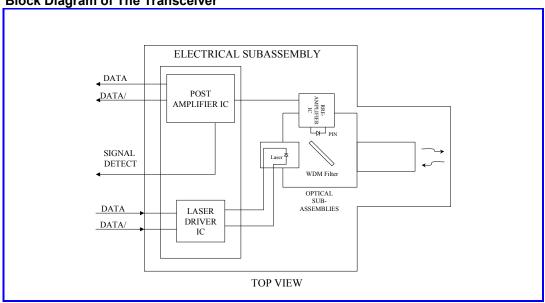
PD-LD Inc. offers single mode laser based fiber optic transceiver modules in convenient industry standard 1x9 style packages. The PTR155 series modules are designed to comply with SONET/SDH 155 Mbps operation over 9/125um single mode optical fiber.

A 1310 nm (-B35) or 1550nm (-B53) FP laser and an InGaAs PIN photodiode are integrated with a WDM filter to form a bi-directional single fiber optical subassembly (OSA). A LD driver IC that converts differential input LVPECL logic signals into an analog laser driving current drives the laser. The photodiode

is connected to a circuit providing post-amplification, quantization, and optical signal detection.

Signal Detect indicates the receiving of a good optical signal. This is a single-ended LVPECL output. When the input optical power decreases, Signal Detect will change from high state to low state at a level (de-assert point) below the sensitivity. As the input optical power increases, Signal Detect will change back from low state to high state at assert point. The assert level is at least 1.0 dBm higher than the de-assert level.

**Block Diagram of The Transceiver** 



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Ordering Information

PART NUMBER	TX	RX	VOLTAGE	TEMPERATURE
PTR155-B35-01	1310 nm	1550 nm	3.3 V	0 °C to 70 °C
PTR155-B35-02	1310 nm	1550 nm	3.3 V	-40 °C to 85 °C
PTR155-B53-01	1550 nm	1310 nm	3.3 V	0 °C to 70 °C
PTR155-B53-02	1550 nm	1310 nm	3.3 V	-40 °C to 85 °C

**Absolute Maximum Ratings** 

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Parameter	Symbol	Min.	Max.	Units	Note			
Storage Temperature	$T_{\mathtt{S}}$	-40	85	°C				
Supply Voltage	Vcc	-0.5	4.0	V				
Input Voltage	$V_{IN}$	-0.5	Vcc	V				
Output Current	I <sub>o</sub>		50	mA				
Operating Current	l <sub>OP</sub>		400	mA				
Soldering Temperature	$T_{SOLD}$		260	°C	10 seconds on leads			

**Recommended Operating Conditions** 

Parameter	Symbol	Min.	Max.	Untis	Note
Case Operating Temperature	0 70		°C	-01 models	
Case Operating Temperature	/ C	-40	-02 models		
Supply Voltage	Vcc	3.3	3.6	V	
Supply Current	$I_{TX} + I_{RX}$		200	mΑ	

### **Transmitter Electro-optical Characteristics**

 $Vcc = 4.75 \text{ V to } 5.25 \text{ V}, T_A = 0^{\circ} \text{C to } 70^{\circ} \text{C } (-40^{\circ} \text{C to } 85^{\circ} \text{C})$ 

Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Data Rate	В	50	155	200	Mb/s	
Output Optical Power 9/125 $\mu$ m fiber	Pout	<b>-9</b>		-3	dBm	Average
Extinction Ratio	ER	9			dB	
Center Wavelength (-B53)	1	1480	1550	1580	nm	
(-B35)	λc	1260	1310	1360	- nm	
Spectral Width (RMS)	Δλ			4	nm	
Rise/Fall Time, 10%~90%	$T_{pf}$		1	2	ns	
Output Eye	Compliant with Telcordia GR-253-CORE Issue 3 and ITU-T recommendation G-957					
Data Input Voltage-High	$V_{IH} - V_{CC}$	-1.1		-0.74	V	Note 1
Data Input Voltage-Low	$V_{IL} - V_{CC}$	-2.0		-1.58	V	Note 1
Data Input Differential Voltage	$V_{\it DIFF}$	0.3		1.6	V	Note 1
Note 1: These inputs are compatible with 10K 10KH and 100K ECL and PECL input						

Note 1: These inputs are compatible with 10K, 10KH and 100K ECL and PECL input.

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## **Receiver Electro-optical Characteristics**

 $Vcc = 4.75 \text{ V to } 5.25 \text{ V}, T_{\Delta} = 0 ^{\circ}\text{C to } 70 ^{\circ}\text{C } (-40 ^{\circ}\text{C to } 85 ^{\circ}\text{C})$ 

Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Data Rate	В	50	155	200	Mb/s	
Optical Input Power-maximum	$P_{IN}$	0			dBm	Note 1
Optical Input Power-minimum (Sensitivity)	P <sub>IN</sub>			-31	dBm	Note 1
Operating Wavelength (-B53)	1	1260		1360	nm	
(-B35)	λ <sub>c</sub> -	1480		1600	11111	
Return Loss	RL			-14	dB	λ=1260~1360nm λ=1400~1600nm
Signal Detect-Asserted	$P_A$			-31	dBm	Average
Signal Detect-De-asserted	$P_D$	<del>-4</del> 5			dBm	Average
Signal Detect-Hysteresis	$P_A - P_D$	1.0			dB	
Signal Detect Output voltage - High	$V_{OH} - V_{CC}$	-1.1		-0.74	V	Note 2
Signal Detect Output voltage - Low	$V_{OL} - V_{CC}$	-2.0		-1.58	V	Note 2
Crosstalk	CRT			<del>-4</del> 5	dB	
Data Output Rise, Fall Time	$T_{r,f}$		1	2	ns	
Data Output Voltage-High	$V_{OH} - V_{CC}$	-1.1		-0.74	V	Note 2
Data Output Voltage-Low	$V_{oL} - V_{CC}$	-2.0		-1.58	V	Note 2

Note 1: The input data is at 155.52 Mbps,  $2^{23}$  – 1 PRBS data pattern with 72 "1"s and 72 "0"s inserted per the ITU-T recommendation G.958 Appendix 1. The receiver is guaranteed to provide output data with Bit Error Rate (BER) better than or equal to 1×10<sup>-10</sup>.

Note 2: These outputs are compatible with 10K, 10KH and 100K ECL and PECL input.

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n-Out	
1. RX GND	O N/C
2. <i>RD</i> +	O
3. <i>RD</i> -4. <i>SD</i>	
4. SD 5. VCCR	TOP VIEW
6. Vcct	
7. TD-	
8. <i>TD</i> +	O N/C
9. TX GND	J

Pin	Symbol	Description
1	RX GND	Receiver Signal Ground This pin should be connected directly to the receiving ground plane
2	RD+	RD+ is an open-emitter output signal.  This high-speed differential LVPECL output should be terminated with standard PECL termination
3	RD-	close the input pin of the next-stage device. (See recommended connection diagram)  RD— is an open-emitter output signal.  This high-speed differential LVPECL output should be terminated with standard PECL termination close the input pin of the next-stage device. (See recommended connection diagram)
4	SD	Signal Detect. SD outputs a logic "1" (asserted) when optical input is above the asserted levels, and a logic "0" (deasserted) when the optical input is below the de-assert level. SD can be terminated with 50 $\Omega$ to $V_{CCR}$ – 2 V, or with a 510 $\Omega$ resistor to the RX GND to conserve electrical power with a minor compromise to signal quality. If Signal Detect output is not used, it can be left open. This Signal Detect output can be used to drive a PECL input.
5	V <sub>CCR</sub>	Receiver Power Supply This pin should be connected to +3.3 Vdc with proper filtering closely located.
6	V <sub>CCT</sub>	Transmitter Power Supply This pin should be connected to +3.3 Vdc with proper filtering closely located.
7	TD-	Transmitter Data In-Bar This high-speed differential LVPECL input should be terminated with standard PECL termination close the pin. (See recommended connection diagram)
8	TD+	Transmitter Data In This high-speed differential LVPECL input should be terminated with standard PECL termination close the pin. (See recommended connection diagram)
9	TX GND	Transmitter Signal Ground This pin should be connected directly to the transmitting ground plane

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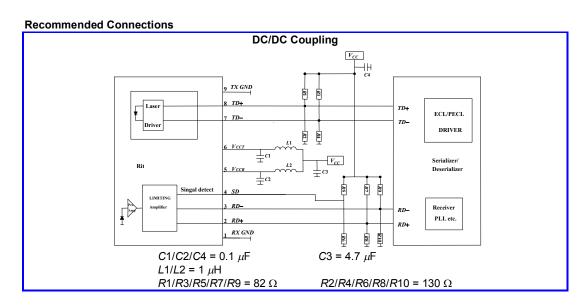
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A connection circuit is recommended in the above diagram. The following guidelines are also recommended for designing the interface circuit:

- (1) The differential data lines should be treated as 50 Ω Micro strip or strip line transmission lines. This will help to minimize the parasitic inductance and capacitance effects. Locate termination at the received signal end of the transmission line. The length of these lines should be kept short and of equal length.
- (2) For the high speed signal lines, differential signals should be used, not single-ended signals, and these differential signals need to be loaded symmetrically to prevent unbalanced currents which will cause distortion in the signal.
- (3) Multi layer plane PCB is best for distribution of  $V_{\rm CC}$ , returning ground currents, forming transmission lines and shielding, Also, it is important to suppress noise from influencing the fiber-optic transceiver performance, especially the receiver circuit.
- (4) A separate proper power supply filter circuits shown in Figure for the transmitter and receiver sections. These filter circuits suppress V<sub>cc</sub> noise over a broad frequency range. this prevents receiver sensitivity degradation due to V<sub>cc</sub> noise.
- (5) Surface-mount components are recommended. Ceramic bypass capacitors should be used for the 0.1  $\mu$ F capacitors and a surface-mount coil inductor for 1  $\mu$ H inductor. Ferrite beads can be used to replace the coil inductors when using quieter  $V_{CC}$  supplies, but a coil inductor is recommended over a ferrite bead. All power supply components need to be placed physically next to the  $V_{CC}$  pins of the receiver and transmitter.
- (6) A good, uniform ground plane with a minimum number of holes should be used to provide a low-inductance ground current return for the power supply currents.

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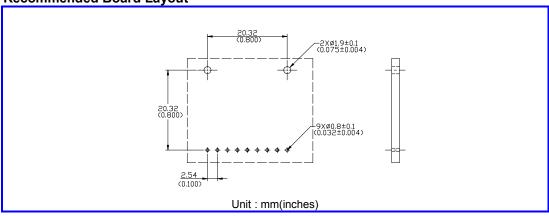


# **Dimensions** 0.4±0.10 9.5±0.15 20.32 25.4 2.54±0.1 Ø 0.45±0.10 39. 2.1±0.1 3.30±0.30 12.7±0.15 Ø 1.30±0.1 ALL DIMENSIONS ARE±0.20mm UNLESS OTHERWISE SPECIFIED Unit: mm

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## **Recommended Board Layout**



This transceiver is compatible with industry standard wave or hand solder processes. After wash process, all moisture must be completely removed from the module. The transceiver is supplied with a process plug to prevent contamination during wave solder and aqueous rinse as well as during handling, shipping or storage.

Solder fluxes should be water-soluble, organic solder fluxes. Cleaning and degreasing chemicals recommended for these transceivers are alcohol-based (methyl, isopropyl, isobutyl), aliphatic-based (hexane, heptanes) and other chemicals, such as soap solution or naphtha. Do not use partially halogenated hydrocarbons for cleaning/degreasing.

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